

# NP75N04YUG

#### MOS FIELD EFFECT TRANSISTOR

R07DS0018EJ0100 Rev.1.00 Jul 01, 2010

#### **Description**

The NP75N04YUG is N-channel MOS Field Effect Transistor designed for high current switching applications.

#### **Features**

- Low on-state resistance
  - ---  $R_{DS(on)}$  = 4.8 mΩ MAX. ( $V_{GS}$  = 10 V,  $I_D$  = 37.5 A)
- Low Ciss: Ciss = 4300 pF TYP.  $(V_{DS} = 25 \text{ V}, V_{GS} = 0 \text{ V})$
- Designed for automotive application and AEC-Q101 qualified
- Small size package 8-pin HSON

#### **Ordering Information**

Part No.	LEAD PLATING	PACKING	Package
NP75N04YUG -E1-AY *1	Pure Sn (Tin)	Tape 2500 p/reel	8-pin HSON, Taping (E1 type)
NP75N04YUG -E2-AY *1			8-pin HSON, Taping (E2 type)

Note: \*1. Pb-free (This product does not contain Pb in the external electrode.)

#### Absolute Maximum Ratings ( $T_A = 25$ °C)

Item	Symbol	Ratings	Unit
Drain to Source Voltage (V <sub>GS</sub> = 0 V)	$V_{DSS}$	40	V
Gate to Source Voltage (V <sub>DS</sub> = 0 V)	$V_{GSS}$	±20	V
Drain Current (DC) (T <sub>C</sub> = 25°C)	I <sub>D(DC)</sub>	±75	Α
Drain Current (pulse) *1	I <sub>D(pulse)</sub>	±225	Α
Total Power Dissipation (T <sub>C</sub> = 25°C)	P <sub>T1</sub>	138	W
Total Power Dissipation (T <sub>A</sub> = 25°C) *2	P <sub>T2</sub>	1.0	W
Channel Temperature	T <sub>ch</sub>	175	°C
Storage Temperature	T <sub>stg</sub>	-55 to +175	°C
Repetitive Avalanche Current *3	I <sub>AR</sub>	35	Α
Repetitive Avalanche Energy *3	E <sub>AR</sub>	123	mJ

#### **Thermal Resistance**

Notes: \*1.  $T_C = 25^{\circ}C$ , PW  $\leq 10 \mu s$ , Duty Cycle  $\leq 1\%$ 

\*2. Mounted on glass epoxy substrate of 40 mm x 40 mm x 0.8 mmt

\*3.  $T_{ch(peak)} \le 150^{\circ}C$ ,  $R_G = 25 \Omega$ 

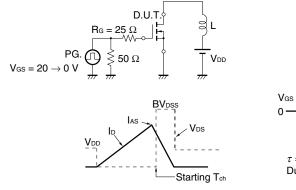
### Electrical Characteristics ( $T_A = 25^{\circ}C$ )

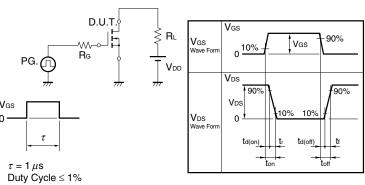
Item	Symbol	Min	Тур	Max	Unit	Test Conditions
Zero Gate Voltage Drain Current	I <sub>DSS</sub>			1	μA	$V_{DS} = 40 \text{ V}, V_{GS} = 0 \text{ V}$
Gate Leakage Current	I <sub>GSS</sub>			±100	nA	$V_{GS} = \pm 20 \text{ V}, V_{DS} = 0 \text{ V}$
Gate to Source Threshold Voltage	$V_{GS(th)}$	2.0	3.0	4.0	V	$V_{DS} = V_{GS}, I_{D} = 250 \mu\text{A}$
Forward Transfer Admittance *1	y <sub>fs</sub>	23	46		S	$V_{DS} = 5 \text{ V}, I_{D} = 37.5 \text{ A}$
Drain to Source On-state Resistance *1	R <sub>DS(on)</sub>		3.8	4.8	mΩ	V <sub>GS</sub> = 10 V, I <sub>D</sub> = 37.5 A
Input Capacitance	C <sub>iss</sub>		4300	6450	pF	$V_{DS} = 25 V$ ,
Output Capacitance	Coss		400	600	pF	$V_{GS} = 0 V$ ,
Reverse Transfer Capacitance	C <sub>rss</sub>		250	450	pF	f = 1 MHz
Turn-on Delay Time	t <sub>d(on)</sub>		27	54	ns	$V_{DD}$ = 20 V, $I_{D}$ = 37.5 A,
Rise Time	t <sub>r</sub>		10	25	ns	$V_{GS}$ = 10 $V$ ,
Turn-off Delay Time	$t_{d(off)}$		66	132	ns	$R_G = 0 \Omega$
Fall Time	t <sub>f</sub>		6	15	ns	
Total Gate Charge	$Q_G$		77	116	nC	V <sub>DD</sub> = 32 V,
Gate to Source Charge	$Q_{GS}$		20		nC	$V_{GS} = 10 \text{ V},$
Gate to Drain Charge	$Q_{GD}$		25		nC	I <sub>D</sub> = 75 A
Body Diode Forward Voltage *1	$V_{F(S-D)}$		0.93	1.5	V	I <sub>F</sub> = 75 A, V <sub>GS</sub> = 0 V
Reverse Recovery Time	t <sub>rr</sub>		39		ns	$I_F = 75 \text{ A}, V_{GS} = 0 \text{ V},$
Reverse Recovery Charge	Q <sub>rr</sub>		46		nC	di/dt = 100 A/μs

Note: \*1. Pulsed

#### **TEST CIRCUIT 1 AVALANCHE CAPABILITY**

#### TEST CIRCUIT 2 SWITCHING TIME

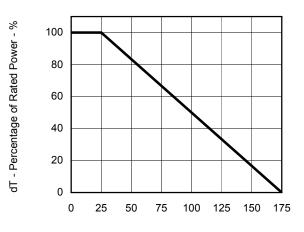




#### **TEST CIRCUIT 3 GATE CHARGE**

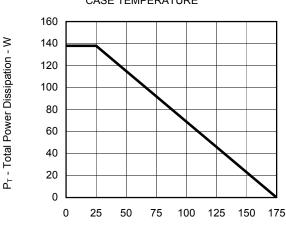
#### Typical Characteristics ( $T_A = 25^{\circ}C$ )

DERATING FACTOR OF FORWARD BIAS SAFE OPERATING AREA



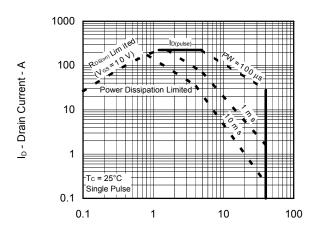
T<sub>C</sub> - Case Temperature - °C

#### TOTAL POWER DISSIPATION vs. CASE TEMPERATURE



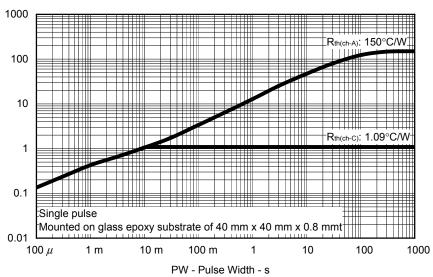
T<sub>C</sub> - Case Temperature - °C

#### FORWARD BIAS SAFE OPERATING AREA



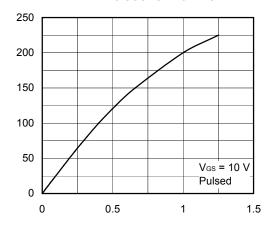
 $V_{\text{\scriptsize DS}}$  - Drain to Source Voltage - V

#### TRANSIENT THERMAL RESISTANCE vs. PULSE WIDTH

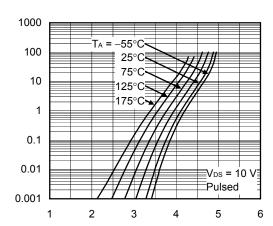


I<sub>D</sub> - Drain Current - A





# Ip - Drain Current - A

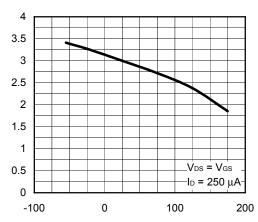


FORWARD TRANSFER CHARACTERISTICS

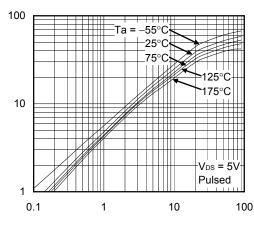
 $V_{\text{GS}}$  - Gate to Source Voltage - V

#### $V_{\text{DS}}$ - Drain to Source Voltage - V

#### GATE TO SOURCE THRESHOLD VOLTAGE vs. CHANNEL TEMPERATURE



#### FORWARD TRANSFER ADMITTANCE vs. DRAIN **CURRENT**



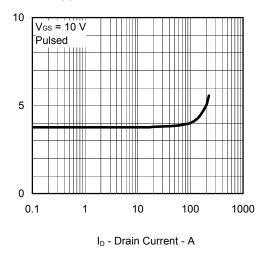
T<sub>ch</sub> - Channel Temperature - °C ID - Drain Current - A

 $\mathsf{R}_{\mathsf{DS}(\mathsf{on})}$  - Drain to Source On-state Resistance -  $m\Omega$ 

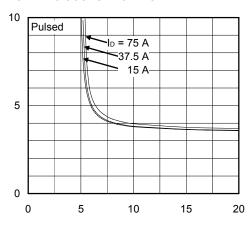
RENESAS

y<sub>fs</sub> | - Forward Transfer Admittance - S

#### DRAIN TO SOURCE ON-STATE RESISTANCE vs. **DRAIN CURRENT**



DRAIN TO SOURCE ON-STATE RESISTANCE vs. GATE TO SOURCE VOLTAGE



 $V_{\text{GS}}$  - Gate to Source Voltage - V

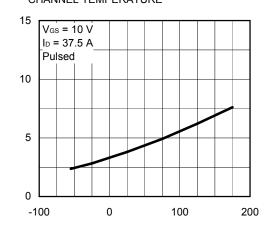
V<sub>GS(th)</sub> - Gate to Source Threshold Voltage - V

 $R_{\text{DS}(\text{on})}$  - Drain to Source On-state Resistance -  $m\Omega$ 

t<sub>d(on)</sub>, t<sub>r</sub>, t<sub>d(off)</sub>, t<sub>f</sub> - Switching Time - ns

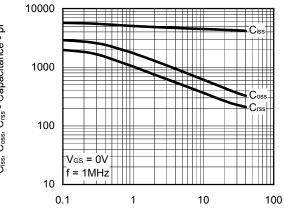
I<sub>F</sub> - Diode Forward Current - A

# DRAIN TO SOURCE ON-STATE RESISTANCE vs. CHANNEL TEMPERATURE



#### $T_{\text{ch}}$ - Channel Temperature - $^{\circ}C$

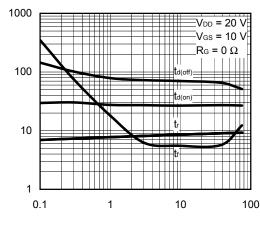
# Ciss, Coss, Crss - Capacitance - pF



CAPACITANCE vs. DRAIN TO SOURCE VOLTAGE

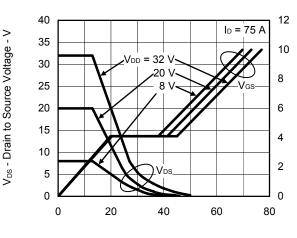
V<sub>DS</sub> - Drain to Source Voltage - V

#### SWITCHING CHARACTERISTICS



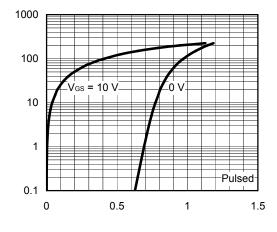
ID - Drain Current - A

#### DYNAMIC INPUT/OUTPUT CHARACTERISTICS



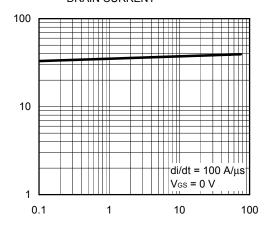
Q<sub>G</sub> - Gate Charge - nC

#### SOURCE TO DRAIN DIODE FORWARD VOLTAGE



 $V_{\text{F(S-D)}}$  - Source to Drain Voltage - V

## REVERSE RECOVERY TIME vs. DRAIN CURRENT

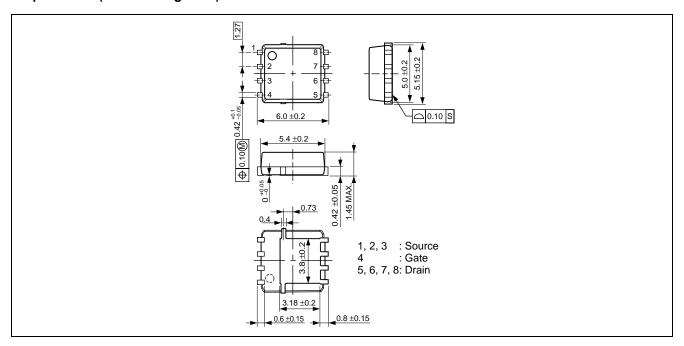


I<sub>F</sub> - Drain Current - A

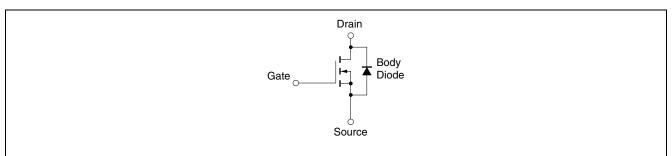
t<sub>rr</sub> - Reverse Recovery Time - ns

#### Package Drawings (Unit: mm)

8-pin HSON (Mass: 0.13 g TYP.)



#### **Equivalent Circuit**



**Remark** Strong electric field, when exposed to this device, can cause destruction of the gate oxide and ultimately degrade the device operation. Steps must be taken to stop generation of static electricity as much as possible, and quickly dissipate it once, when it has occurred.

Revision History NP75N04YUG

		Description		
Rev.	Date	Page	Summary	
1.00	Jul 01, 2010	-	First Eddition Issued	

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